



DESCRIPTION

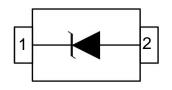
The KESD3.3V52D-C designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium. Because of its small size, it is suited for use in cellular phones, portable devices, digital cameras, power supplies and many other portable applications.

ORDERING INFORMATION

♦ Package: SOD-523 ♦ Material: Halogen free ♦ Packing: Tape & Reel

♦ Quantity per reel: 3,000pcs

PIN CONFIGURATION



FEATURES

- ♦IEC61000-4-2 Level 4 ESD Protection
- ♦ Protects one directional I/O line
- ♦Low clamping voltage
- ♦Low leakage current

MACHANICAL DATA

- ♦SOD-523 package
- ♦Flammability Rating: UL 94V-0
- ♦ Packaging: Tape and Reel
- → High temperature soldering guaranted:260 °C/10s
- ♦Reel size: 7 inch

APPLICATIONS

- ♦ Cell Phone Handsets and Accessories
- ♦ Microprocessor based equipment
- ♦ Personal Digital Assistants (PDA's)
- ♦Notebooks, Desktops, and Servers
- ♦Portable Instrumentation
- ♦ Peripherals
- **♦Pagers**

PACKAGE OUTLINE



ABSOLUTE MAXIMUM RATING										
Symbol	Parameter	Value	Units							
V _{ESD}	ESD per IEC 61000-4-2 (Air)	±30	kV							
	ESD per IEC 61000-4-2 (Contact)	±22								
ESD	ESD Voltage per human body model	16	kV							
	ESD Voltage per machine model	400	V							
P_D	Total Power Dissipation on FR-5 Board (Note 1) @ Ta=25°C	150	mW							
$T_{J_i}T_{STG}$	Junction and Storage Temperature	-55/+150	°C							
T_L	Lead Solder Temperature – Maximum (10 Second Duration)	260	°C							

These ratings are limiting values above which the serviceability of the diode may be impaired Note 1. FR-5=1.0x0.75x0.62 in.



ELECTRICAL CHARACTERISTICS (Tamb=25°C)												
PART NUMBER	V _{RWM} (V)	I _R (μΑ)	V _B (V)	I _T (mA)	V _C V _C (V)		_	P _{PK} (W)	C _J (pF)			
NOMBER	Max	Max	Min		Max	@A	Max	@A	Max	Max		
KESD3.3V52D-C	3.3	0.90	5.0	1	10.0	5.0	14.0	7.5	105	105		

